



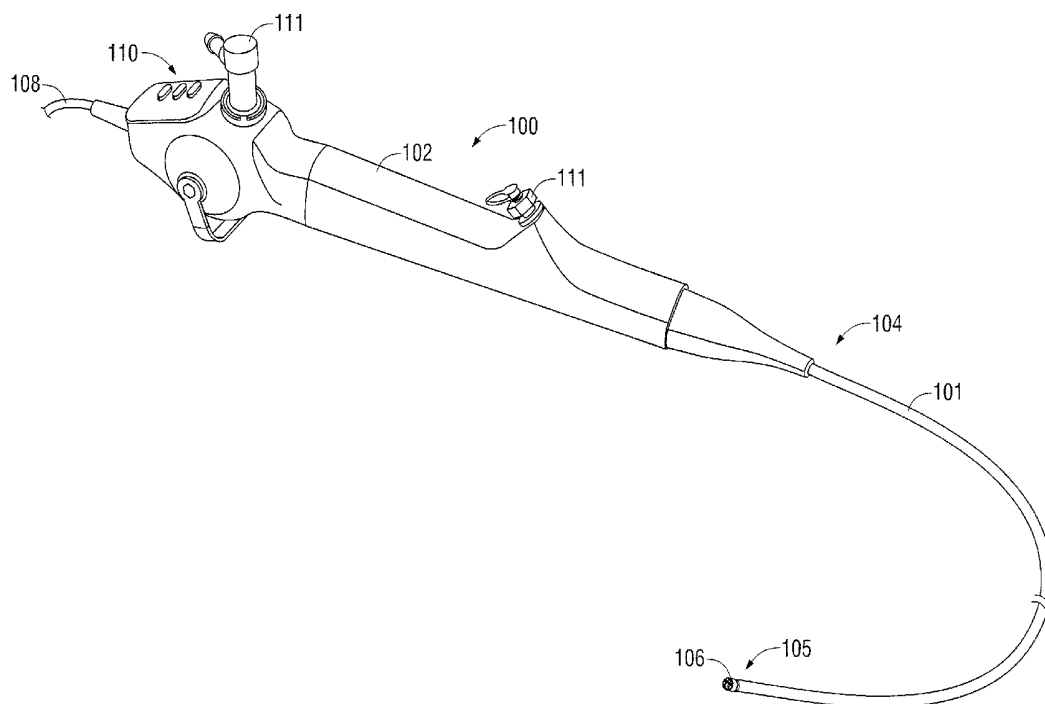
(12) **Patent Application Publication**
Birnkrant

(43) **Pub. Date:** **Nov. 30, 2017**

- (52) **U.S. Cl.**
CPC **F21V 29/70** (2015.01); **H01L 33/64**
(2013.01); **H01L 33/642** (2013.01); **H01L**
33/62 (2013.01); **A61B 1/0684** (2013.01);
F21V 19/0025 (2013.01); **F21V 5/04**
(2013.01); **G02B 23/2461** (2013.01)

A heat sink includes first and second elongated heat sink bodies. The first and second elongated heat sink bodies are each formed from a respective electrically and thermally conductive material and also each extend from an LED coupling end of the heat sink to a lead end of the heat sink. An electrical insulator material connects the first and second elongated heat sink bodies together so as to bodies are electrically isolated from each other. Each elongated heat sink body also includes a respective LED coupling surface at the LED coupling end of the heat sink and a respective lead connecting surface located on the respective body at a location spaced apart from the LED coupling end of the heat sink.

(51) **Int. Cl.**
F21V 29/70 (2006.01)
H01L 33/62 (2010.01)
G02B 23/24 (2006.01)
F21V 19/00 (2006.01)
F21V 5/04 (2006.01)



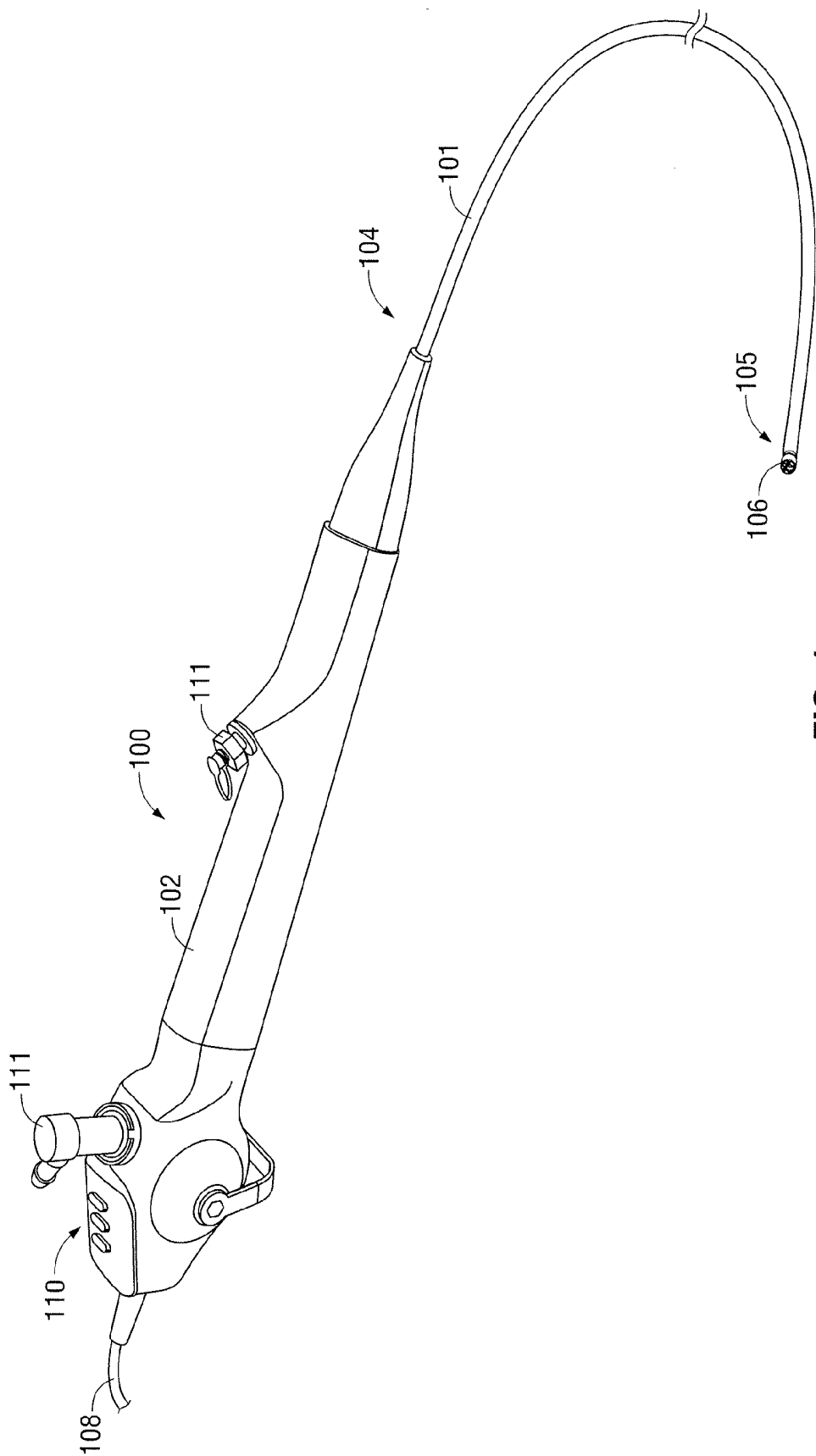


FIG. 1

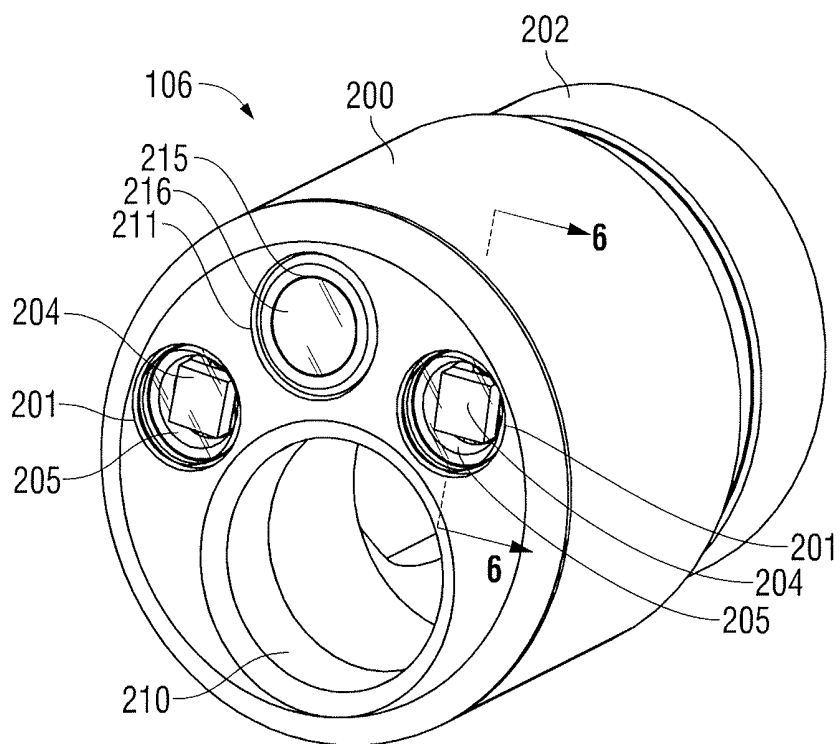


FIG. 2

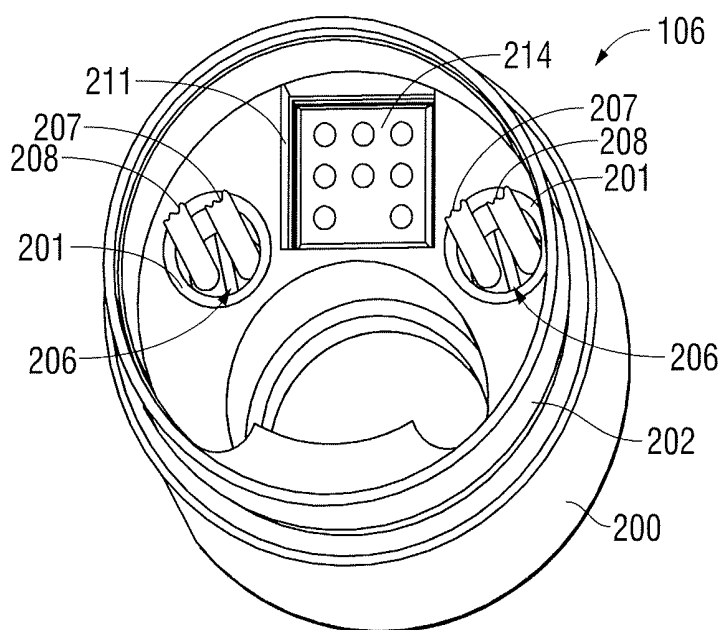


FIG. 3

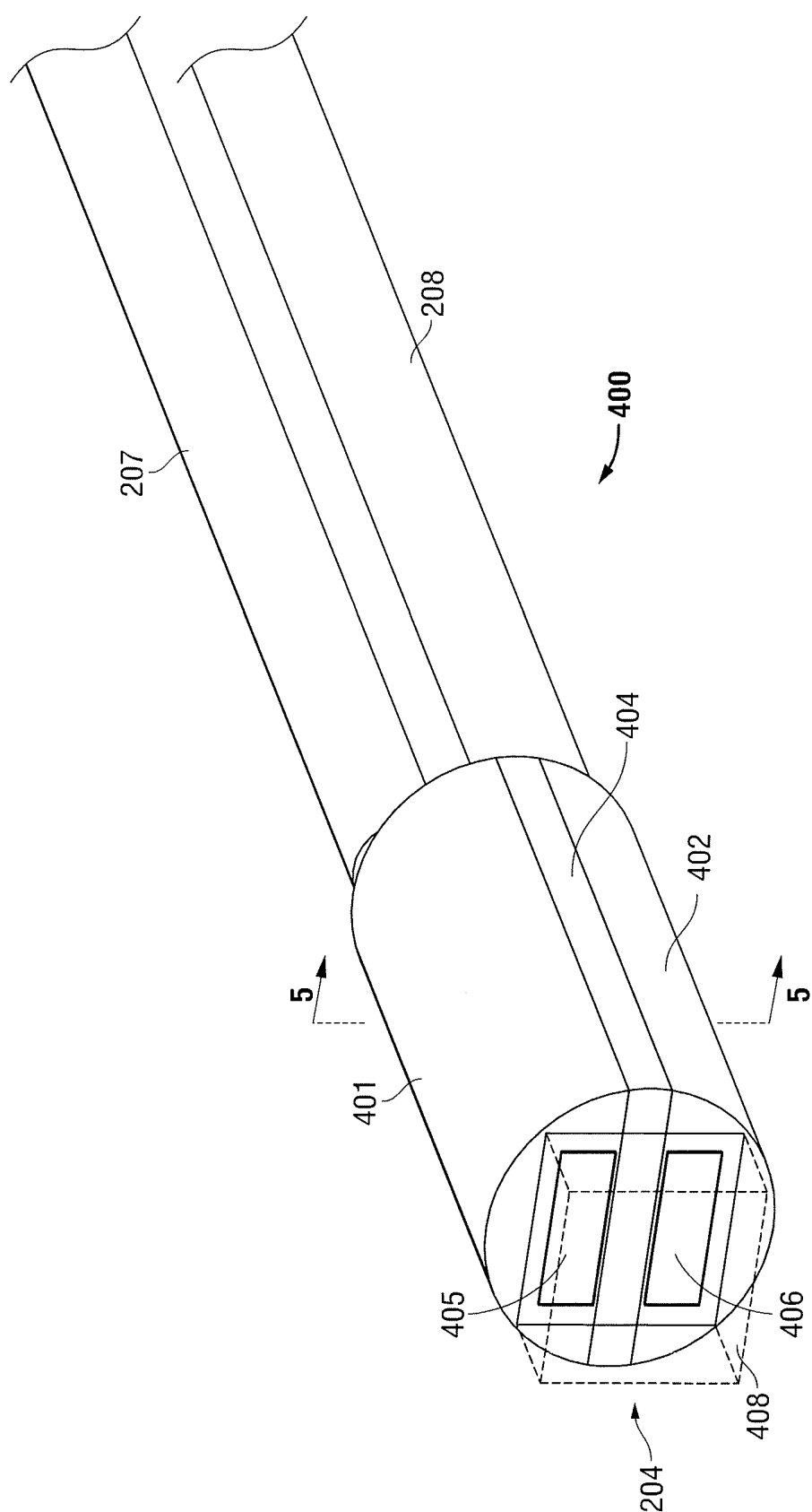


FIG. 4

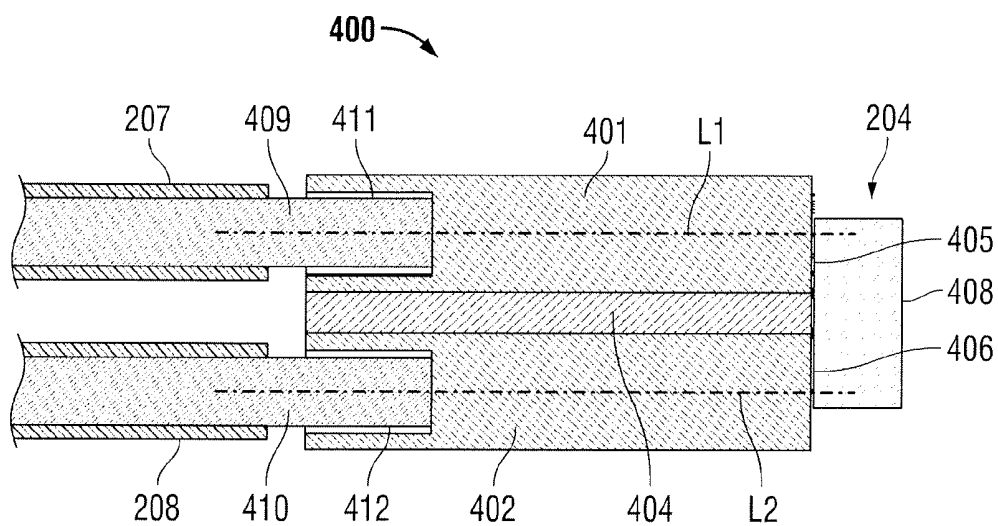


FIG. 5

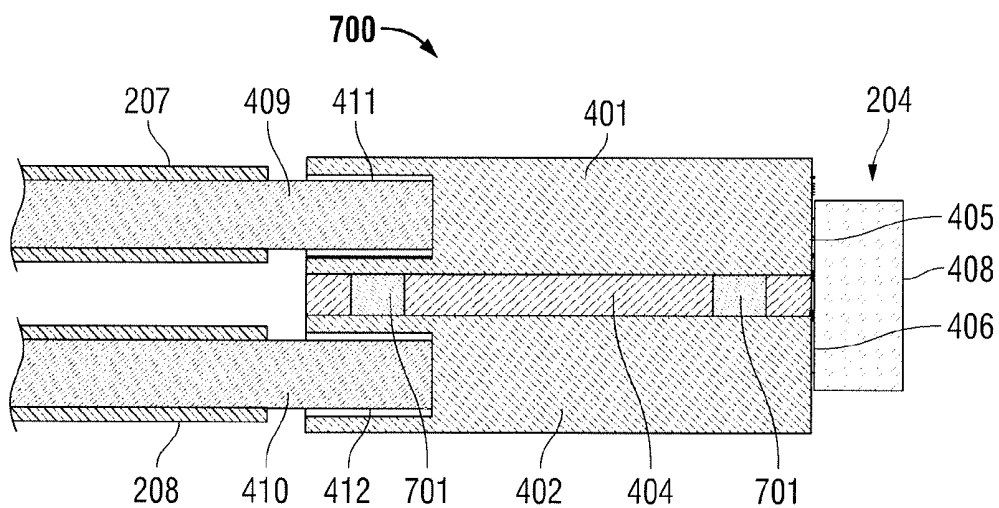


FIG. 7

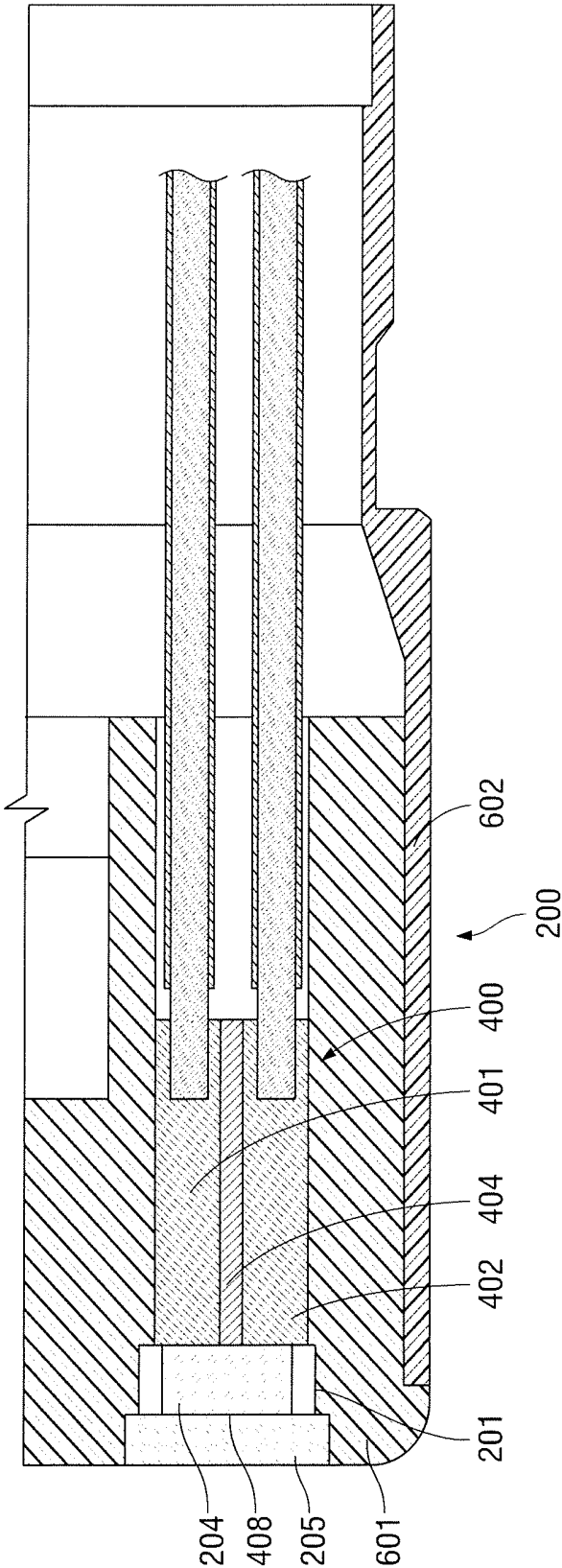


FIG. 6

HEAT SINK STRUCTURE AND LED HEAT SINK ASSEMBLIES

TECHNICAL FIELD OF THE INVENTION

[0001] The invention relates to illumination systems for use in devices such as endoscopes. More particularly, the invention encompasses heat sinks, heat sink and LED assemblies, and devices incorporating such assemblies.

BACKGROUND OF THE INVENTION

[0002] Observation instruments such as endoscopes are used in medical and other applications to allow a visual inspection of locations which are not readily accessible. For example, endoscopes are used in medical applications to provide a view of an area within a patient's body. An endoscope typically includes an elongated shaft of relatively small diameter extending from a handle to a distal end. An imaging or viewing arrangement is included with the endoscope to allow a user to obtain a view from the distal end. This arrangement may include a system of lenses and a light conduit through the shaft to direct an image from the distal end to an eyepiece associated with the endoscope handle. Alternatively, the imaging or viewing arrangement may include an electronic imaging device at the distal end of the endoscope. Such an electronic imaging device collects image data and communicates that data through the shaft and handle ultimately to a processing system that assembles the data into an image displayed on a suitable display device. Whether the location at the distal end of the endoscope is viewed directly, or imaged electronically, the location must be illuminated sufficiently.

[0003] To provide the desired illumination, light may be generated by a light source at the endoscope handle and directed through suitable conduits in the shaft (such as optical fibers for example) to the endoscope distal end where the light can be directed as desired through suitable lenses. Alternatively to relying on light conducted through the shaft to the distal end of the endoscope, a suitable light source such as an LED lamp may be placed at the distal end of the endoscope to provide the required illumination. Although placement of a light source at the distal end of the endoscope provides a number of advantages, such an arrangement raises certain challenges. One challenge is that the light source and its associated electrical connections must remain small enough to fit in the distal end of the endoscope along with the objective lens for the imaging/viewing system and other elements which may be included at the distal end. Another challenge, particularly in medical applications, is that the light source must be capable of providing the desired illumination without heating the distal end of the endoscope beyond acceptable levels. Generally, the distal end of the endoscope must remain below 40° C. Thus any distal end light source must be capable of operating without releasing excessive heat to other elements within the distal end assembly.

[0004] Thermal management systems have been developed for addressing the issue of heat generated by illumination devices in endoscopes. U.S. Patent Application Publication No. 2011/0306834 discloses an endoscope with a heat pipe arranged to conduct heat away from a light source at the distal end of an endoscope. The arrangement shown in this prior publication includes a light source thermally coupled to two heat coupling elements which are in turn

thermally coupled to the heat pipe. The heat pipe extends from the distal end of the endoscope to a heat sink at the opposite end of the shaft. Electrical power for the light source in U.S. Patent Application Publication No. 2011/0306834 is provided through wires which extend through the endoscope shaft alongside the heat pipe and heat coupling elements. While this prior system provides an arrangement for conducting heat away from a light source at a distal end of the endoscope, it does so at the cost of the added heat pipe taking up space within the shaft of the endoscope.

[0005] U.S. Patent Application Publication No. 2016/0000309 discloses an LED assembly in which an LED is mounted on a first conductor which is surrounded by a conductive sleeve. One electrical contact of the LED is coupled to the first conductor, while the other electrical contact of the LED is connected to the sleeve via a conductive tab. Both the first conductor and the conductive sleeve in this arrangement can dissipate waste heat from the LED. However, the sleeve required in the structure disclosed in U.S. Patent Publication No. 2016/0000309 increases the transverse dimension of the LED assembly, and also complicates manufacturing.

[0006] There remains a need for compact arrangements which can effectively conduct heat away from a light source mounted at the distal end of an observation instrument such as an endoscopic device.

SUMMARY OF THE INVENTION

[0007] It is an object of the invention to provide a heat sink particularly for use with a light source such as an LED mounted at the distal end of an optical scope. The invention also encompasses an LED and heat sink assembly as well as an observation instrument including such an LED and heat sink assembly.

[0008] A heat sink according to one aspect of the present invention includes first and second elongated heat sink bodies each defining a respective longitudinal axis and positioned substantially parallel to each other. The first and second elongated heat sink bodies are each formed from a respective electrically and thermally conductive material and also each extend from an LED coupling end of the heat sink to a lead end of the heat sink. An electrical insulator material connects the first and second elongated heat sink bodies together so as that bodies are electrically isolated from each other. Each elongated heat sink body also includes a respective LED coupling surface. A first LED coupling surface defines an end surface of the first elongated heat sink body at the LED coupling end of the heat sink, while a second LED coupling surface defines an end surface of the second elongated heat sink body at the LED coupling end of the heat sink. Each elongated heat sink body also includes a respective lead connecting surface located on the respective body at a location spaced apart from the LED coupling end of the heat sink.

[0009] The combination of the two substantially parallel elongated heat sink bodies of both thermally and electrically conductive material together with their electrical isolation and LED coupling surfaces according to this first aspect of the invention provides a number of advantages. One advantage is that the electrodes of an LED may be soldered or otherwise electrically connected directly to the elongated heat sink bodies. The elongated heat sink bodies may thus provide a power connection to the LED while simultaneously providing a good thermal conduction path to conduct

heat away from the LED to electrically conductive leads which may be soldered or otherwise electrically connected to the respective lead connecting surfaces. Another advantage of the heat sink arrangement according to this first aspect of the invention is that the elongated heat sink bodies may be arranged to provide a very compact transverse shape. Thus the heat sink makes very efficient use of the limited space within the optical scope distal end.

[0010] According to another aspect of the invention, an LED and heat sink assembly includes an LED having a light emitting side and a contact side. The contact side is opposite to the light emitting side and includes an anode and a cathode located at spaced apart positions. A first elongated heat sink body defines a first longitudinal axis extending transverse to the contact side of the LED, and has an LED coupling surface at one end in electrical contact with the anode of the LED. A second elongated heat sink body defines a second longitudinal axis also extending transverse to the contact side of the LED, and has an LED coupling surface at one end in electrical contact with the cathode of the LED. Both of the first and second elongated heat sink bodies are formed from a respective electrically and thermally conductive material and the two bodies are connected together by an electrical insulator material so that the two heat sink bodies are electrically isolated from each other along their length. Each elongated heat sink body includes a respective lead connecting surface located on the respective body at a location spaced apart from the LED, and preferably at the end opposite to that connected to the LED.

[0011] The LED and heat sink assembly according to this second aspect of the invention is well adapted for use in small assemblies such as those making up the distal end of an optical scope. In particular, the distal end of an optical scope may include a sleeve having openings defined therein for receiving the various components of the distal end assembly. In this arrangement, the LED and heat sink assembly according to this second aspect of the invention may be inserted LED end first into an opening reserved for the LED and retained in place by a suitable method.

[0012] According to another aspect of the invention, an LED and heat sink assembly according to the second aspect described above is combined with an observation instrument including a handle and shaft. The LED and heat sink assembly is mounted in the observation instrument so that the LED resides at a distal end of the shaft with the light emitting side of the LED facing outwardly.

[0013] In one implementation of a heat sink or heat sink assembly according to any of the foregoing aspects of the invention, the two elongated heat sink bodies each include a respective planar longitudinal face in contact with the electrical insulator material. Regardless of the shape of the connected surfaces of the two heat sink bodies, the electrical insulator material may comprise an epoxy material or any other suitable bonding and electrical insulating material.

[0014] The elongated heat sink bodies may have an external shape which allows the heat sink arrangement to be readily mounted in an assembly. This is particularly helpful in implementations in which the heat sink is incorporated in a compact device such as the distal end of an endoscope. In one preferred implementation, each elongated heat sink body includes a curved outer surface so that the two bodies together form a portion of a cylindrical shape.

[0015] In implementations of a heat sink or heat sink assembly according to any of the foregoing aspects of the

invention, the lead connecting surface of each heat sink body may comprise a feature that facilitates the connection of a conductor for supplying electrical power to the LED. One such feature may comprise a hole drilled or otherwise formed in the end of the respective heat sink body opposite the end coupled (or to be coupled) to the LED. Regardless of whether such a connection facilitating surface is provided as the lead surface of the elongated heat sink body, the power supplying conductor may be soldered to the lead connecting surface or connected in any other way that provides a good electrical and thermal interface between the conductor and the heat sink body. Similarly, the electrodes of the LED at the opposite end of the heat sink structure may be soldered to the respective LED coupling surface or positioned in any other way to provide a good electrical and thermal interface between the respective LED electrode and the respective LED coupling surface.

[0016] It should be noted that although certain implementations of the present invention are described with reference to endoscopes, the invention is certainly not limited to applications in endoscopes. Rather, in implementations according to any of the foregoing aspects of the invention, the observation device in which the heat sink may be employed may be an optical scope such as an endoscope, exoscope, or borescope.

[0017] These and other advantages and features of the invention will be apparent from the following description of representative embodiments, considered along with the accompanying drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

[0018] FIG. 1 is a view in perspective of an endoscope including an LED and heat sink assembly according to an embodiment of the present invention.

[0019] FIG. 2 is a front perspective view of the assembly at the distal end of the endoscope shown in FIG. 1.

[0020] FIG. 3 is a rear perspective view of the assembly shown in FIG. 2.

[0021] FIG. 4 is a view in perspective of an LED and heat sink assembly which may be used in the endoscope distal end assembly shown in FIGS. 2 and 3.

[0022] FIG. 5 is a view in section taken along line 5-5 in FIG. 4.

[0023] FIG. 6 is a view in section taken along line 6-6 in FIG. 2.

[0024] FIG. 7 is a view in section similar to FIG. 5, but showing an embodiment in which shims remain in the heat sink.

DESCRIPTION OF REPRESENTATIVE EMBODIMENTS

[0025] Heat sinks and heat sink assemblies within the scope of the present invention will be described below primarily with reference to applications in an endoscope. This reference to an endoscope is intended merely as a representative example application and is not intended to be limiting. Implementations include other observation instruments including optical scopes such as exoscopes and bore-scopes in addition to endoscopes.

[0026] Referring to FIG. 1, an endoscope 100 employing an LED and heat sink assembly according to one aspect of the present invention includes an elongated shaft 101 and a handle 102. Shaft 101 extends from a proximal end shown

generally at reference numeral **104** connected to handle **102** to a distal end generally indicated at reference numeral **105**. A distal end assembly **106** is included at the shaft distal end **105** and includes one or more LED and heat sink assemblies according to an aspect of the present invention. The LEDs and other features of distal end assembly **106** are not shown in FIG. 1 due to the scale of the figure but will be described in detail below, particularly with reference to FIGS. 2-6.

[0027] Endoscope **100** receives electrical operating power through a cable **108** which extends from a proximal end of handle **102** in this example endoscope. This power may be used to operate the LED or LEDs associated with distal end assembly **106** and other electronic elements associated with the distal end assembly, such as an imaging device which may be located in that assembly. Also, data signals from such an imaging device may be communicated through appropriate conduits within shaft **101** and handle **102** to cable **108**. These data signals may be communicated through cable **108** to processing equipment (not shown) which processes the image data and drives one or more video monitors to display the images collected at distal end assembly **106**. Those familiar with endoscopic systems will appreciate that endoscope **100** includes a number of features such as controls **110** for controlling the operation of the endoscope and ports **111** for introducing fluids or applying a suction to a working channel included in the endoscope. These additional features and the general operation and control of endoscope **100** will not be described further herein in order to avoid obscuring the present invention in unnecessary detail.

[0028] FIGS. 2 and 3 show distal end assembly **106** separated from shaft **101** shown in FIG. 1. In this representative embodiment, distal end assembly **106** includes a sleeve **200** having a front end shown in the perspective of FIG. 2 and a base end shown in the perspective of FIG. 3. The base end of sleeve **200** is shown in FIG. 3 as including a shaft connecting feature **202** which can be inserted into a tube comprising the endoscope shaft (**101** in FIG. 1). Sleeve **200** includes two separate LED assembly receiving openings **201** which are each adapted to receive a respective LED and heat sink assembly according to an aspect of the present invention. In the view of FIG. 2 only the LED **204** of the LED and heat sink assembly is visible through transparent cover or lens **205**. In the view of FIG. 3 only the heat sink inner end (shown generally at reference numeral **206**) is visible along with power supply wires **207** and **208** leading to the heat sink. Further details regarding the placement of the LED and heat sink assemblies within sleeve **200** will be described below with reference to FIG. 6.

[0029] Sleeve **200** also includes a working channel opening **210** and an imaging assembly opening **211**. In this example the imaging assembly includes a CMOS imaging device **214**, the back of which is visible in the view of FIG. 3, and a lens assembly **215**, the outermost part of which is visible in FIG. 2 behind transparent protective cover **216**. Working channel opening **210** may receive the end of a tube which represents a working channel for performing various functions through distal end assembly **106**. In particular, the working channel may be used to apply suction or apply a fluid through the endoscope, or receive a tool which may be operated through the endoscope.

[0030] FIGS. 4 and 5 show one of the LED and heat sink assemblies from sleeve **200** in FIGS. 2 and 3. This LED and heat sink assembly **400** includes LED **204** and a heat sink

which is made up of a first elongated heat sink body **401** and a second elongated heat sink body **402** separated by a layer of electrically insulating material **404**. First heat sink body **401** has a longitudinal axis **L1** that extends essentially parallel to a longitudinal axis **L2** of second heat sink body **402** (the longitudinal axes **L1** and **L2** being shown in FIG. 5). LED **204** is mounted at a first end of the heat sink and is shown in dashed lines in FIG. 4 so that its electrical contact pads (**405** and **406** respectively) are visible in that view. It will be appreciated that these contact pads **405** and **406** are formed on a back (contact) surface of LED **204** opposite a light emitting side **408**. Pad **405** is electrically coupled to an LED coupling surface of elongated heat sink body **401** at the first end of the heat sink, while pad **406** is electrically coupled to an LED coupling surface of elongated heat sink body **402** at that end of the heat sink. At the opposite end of the heat sink, heat sink bodies **401** and **402** are each electrically coupled to a conductor, **409** and **410**, respectively, of power supply wires **208** and **209**. In this arrangement a suitable LED driving signal applied across conductors **409** and **410** causes LED **204** to emit the desired light.

[0031] LED **204** may be coupled to each elongated heat sink body **401** and **402** by any suitable arrangement that provides the required electrical and thermal connection. Preferred implementations may simply solder each LED contact pad **405** and **406** to a respective planar surface which makes up the LED coupling surface of the respective heat sink body. The opposite end of each elongated heat sink body **401** and **402** comprises a lead connection surface which in this case includes a recess or hole **411** and **412**, respectively, formed in the respective body for receiving an end of one of the power supply conductors **409** and **410**. The conductors **409** and **410** may be soldered in place in this arrangement to provide the desired robust connection with good electrical and thermal conduction between each heat sink body **401** and **402** and the respective conductor.

[0032] The section view of FIG. 6 shows heat sink assembly **400** mounted in an operating position within sleeve **200**. In this embodiment, sleeve **200** is made up of an end part **601** and an intermediate part **602**. LED receiving opening **201** is located in end part **601**. The protective cover/lens **205** is mounted at the distal end of LED assembly receiving opening **201** (the leftmost end in the orientation of the figure). In this example, LED and heat sink assembly **400** is placed in the receiving opening **201** with LED **204** having its light emitting side **408** facing and adjacent to cover/lens **205**.

[0033] It should be noted that the sleeve end part **601** shown in FIG. 6 is formed from an electrically non-conductive material. Thus the outer surfaces of the two heat sink bodies **401** and **402** require no cover material and may contact the surfaces of opening **201**. If desired, and certainly where the structure (such as end part **601**) receiving the LED and heat sink assembly is made from an electrically conductive material, an electrically nonconductive sheath (not shown) may be provided over the heat sink so as to separate the two elongated heat sink bodies **401** and **402** from the receiving structure, and maintain electrical isolation between the two heat sink bodies.

[0034] The cylindrical shape of the heat sink made up of bodies **401** and **402** together with insulating layer **404** is preferred because it can be received in a corresponding cylindrically shaped opening in a sleeve such as sleeve **200** (shown in FIGS. 2, 3, and 6). This cylindrical heat sink and

receiving opening make efficient use of the area available in the distal end assembly 106 (FIGS. 2 and 3). However, the invention is certainly not limited to this cylindrical shape.

[0035] FIG. 7 shows a section view of an alternate embodiment of an LED and heat sink assembly 700 according to the present invention. This embodiment is identical to the example shown in FIGS. 4 and 5 except that FIG. 7 shows nonconductive shims 701 located between the two elongated heat sink bodies 401 and 402. Shims 701 may be left over from a manufacturing process for the heat sink assembly 700.

[0036] In the embodiments shown in FIGS. 4-7 each elongated heat sink body 401 and 402 may comprise a block of copper or aluminum or any other suitable material that exhibits both good thermal and electrical conductivity. The insulating material 404 may be any suitable material that maintains electrical isolation between the two heat sink bodies 401 and 402 (at the relatively low voltage which may be applied as the LED driving signal) and bonds the two bodies together. For example, insulating material 404 may comprise a high temperature epoxy.

[0037] As used herein, whether in the above description or the following claims, the terms “comprising,” “including,” “carrying,” “having,” “containing,” “involving,” and the like are to be understood to be open-ended, that is, to mean including but not limited to. Also, it should be understood that the terms “about,” “substantially,” and like terms used herein when referring to a dimension or characteristic of a component indicate that the described dimension/characteristic is not a strict boundary or parameter and does not exclude variations therefrom that are functionally similar. At a minimum, such references that include a numerical parameter would include variations that, using mathematical and industrial principles accepted in the art (e.g., rounding, measurement or other systematic errors, manufacturing tolerances, etc.), would not vary the least significant digit.

[0038] Any use of ordinal terms such as “first,” “second,” “third,” etc., in the following claims to modify a claim element does not by itself connote any priority, precedence, or order of one claim element over another, or the temporal order in which acts of a method are performed. Rather, unless specifically stated otherwise, such ordinal terms are used merely as labels to distinguish one claim element having a certain name from another element having a same name (but for use of the ordinal term).

[0039] In the above descriptions and the following claims, terms such as top, bottom, upper, lower, and the like with reference to a given feature are intended only to identify a given feature and distinguish that feature from other features. Unless specifically stated otherwise, such terms are not intended to convey any spatial or temporal relationship for the feature relative to any other feature.

[0040] The term “each” may be used in the following claims for convenience in describing characteristics or features of multiple elements, and any such use of the term “each” is in the inclusive sense unless specifically stated otherwise. For example, if a claim defines two or more elements as “each” having a characteristic or feature, the use of the term “each” is not intended to exclude from the claim scope a situation having a third one of the elements which does not have the defined characteristic or feature.

[0041] The above described preferred embodiments are intended to illustrate the principles of the invention, but not to limit the scope of the invention. Various other embodi-

ments and modifications to these preferred embodiments may be made by those skilled in the art without departing from the scope of the present invention. For example, in some instances, one or more features disclosed in connection with one embodiment can be used alone or in combination with one or more features of one or more other embodiments. More generally, the various features described herein may be used in any working combination.

1. A heat sink for LEDs, the heat sink including:

- (a) a first elongated heat sink body defining a first longitudinal axis;
- (b) a second elongated heat sink body defining a second longitudinal axis extending substantially parallel to the first longitudinal axis, the first and second heat sink elongated sink bodies each being formed from a respective electrically and thermally conductive material, and each extending from an LED coupling end of the heat sink to a lead end of the heat sink;
- (c) an electrical insulator material connecting the first elongated heat sink body and the second elongated heat sink body together so as to electrically isolate the first elongated heat sink body from the second elongated heat sink body;
- (d) a first LED coupling surface defining an end surface of the first elongated heat sink body at the LED coupling end of the heat sink;
- (e) a second LED coupling surface defining an end surface of the second elongated heat sink body at the LED coupling end of the heat sink;
- (f) a first lead connecting surface located on the first elongated heat sink body at a location spaced apart from the LED coupling end of the heat sink along the first longitudinal axis; and
- (g) a second lead connecting surface located on the second elongated heat sink body at a location spaced apart from the LED coupling end of the heat sink along the second longitudinal axis.

2. The heat sink of claim 1 wherein the first and second elongated heat sink body each includes a respective planar longitudinal face in contact with the electrical insulator material.

3. The heat sink of claim 1 wherein the electrical insulator material comprises an epoxy material.

4. The heat sink of claim 1 wherein the first and second elongated heat sink body each include a curved outer surface so that the heat sink forms a cylindrical shape.

5. The heat sink of claim 1 wherein:

- (a) the first lead connecting surface comprises a first hole formed in the first elongated heat sink body at a second end of the heat sink opposite the LED coupling end of the heat sink; and
- (b) the second lead connecting surface comprises a second hole formed in the second elongated heat sink body at the second end of the heat sink.

6. An LED and heat sink assembly including:

- (a) an LED having a light emitting side and a contact side opposite the light emitting side, an anode and a cathode being located at spaced apart positions on the contact side;
- (b) a first elongated heat sink body having a first LED coupling surface in electrical contact with the anode of the LED, the first elongated heat sink body defining a first longitudinal axis extending transverse to the contact side of the LED;

- (c) a second elongated heat sink body having a second LED coupling surface in electrical contact with the cathode of the LED, the second elongated heat sink body defining a second longitudinal axis extending transverse to the contact side of the LED, the first and second elongated heat sink bodies each being formed from a respective electrically and thermally conductive material;
 - (d) an electrical insulator material connecting the first elongated heat sink body and the second elongated heat sink body together so as to electrically isolate the first elongated heat sink body from the second elongated heat sink body;
 - (e) a first lead connecting surface located on the first elongated heat sink body at a location spaced apart from the LED; and
 - (f) a second lead connecting surface located on the second elongated heat sink body at a location spaced apart from the LED.
- 7.** The LED and heat sink assembly of claim **6** wherein:
- (a) the first LED coupling surface is soldered to the anode of the LED to provide the electrical contact between the first LED coupling surface and the anode of the LED; and
 - (b) the second LED coupling surface is soldered to the cathode of the LED to provide the electrical contact between the second LED coupling surface and the cathode of the LED.
- 8.** The LED and heat sink assembly of claim **6** wherein the first and second elongated heat sink body each includes a respective planar longitudinal face in contact with the electrical insulator material.
- 9.** The LED and heat sink assembly of claim **6** wherein the electrical insulator material comprises an epoxy material.
- 10.** The LED and heat sink assembly of claim **6** wherein the first and second elongated heat sink body each include a curved outer surface so that the first and second elongated heat sink bodies together form a portion of a cylindrical shape.
- 11.** The LED and heat sink assembly of claim **6** wherein:
- (a) the first lead connecting surface comprises a first hole formed in the first elongated heat sink body at an end of the elongated first heat sink body opposite to the first LED coupling surface; and
 - (b) the second lead connecting surface comprises a second hole formed in the second elongated heat sink body at an end of the second elongated heat sink body opposite to the second LED coupling surface.
- 12.** An observation instrument including:
- (a) a handle and shaft;
 - (b) an LED mounted at a distal end of the shaft, the LED having a light emitting side and having a contact side opposite the light emitting side, an anode and a cathode being located at spaced apart locations on the contact side;
 - (c) a first elongated heat sink body having a first LED coupling surface defining an end surface of the first elongated heat sink body in electrical contact with the anode of the LED, the first elongated heat sink body defining a first longitudinal axis extending transverse to the contact side of the LED;
 - (d) a second elongated heat sink body having a second LED coupling surface defining an end surface of the second elongated heat sink body in electrical contact with the cathode of the LED, the second elongated heat sink body defining a second longitudinal axis extending transverse to the contact side of the LED, the first and second elongated heat sink bodies each being formed from a respective electrically and thermally conductive material;
 - (e) an electrical insulator material connecting the first elongated heat sink body and the second elongated heat sink body together so as to electrically isolate the first elongated heat sink body from the second elongated heat sink body;
 - (f) a first lead connecting surface located on the first elongated heat sink body at a location spaced apart from the first LED coupling surface; and
 - (g) a second lead connecting surface located on the second elongated heat sink body at a location spaced apart from the second LED coupling surface.
- 13.** The observation instrument of claim **12** wherein:
- (a) the first LED coupling surface is soldered to the anode of the LED to provide the electrical contact between the first LED coupling surface and the anode of the LED; and
 - (b) the second LED coupling surface is soldered to the cathode of the LED to provide the electrical contact between the second LED coupling surface and the cathode of the LED.
- 14.** The observation instrument of claim **12** wherein the first and second elongated heat sink body each includes a respective planar longitudinal face in contact with the electrical insulator material.
- 15.** The observation instrument of claim **12** wherein the electrical insulator material comprises an epoxy material.
- 16.** The observation instrument of claim **12** wherein the first and second elongated heat sink body each include a curved outer surface forming a portion of a cylindrical shape.
- 17.** The observation instrument of claim **12** wherein:
- (a) the first lead connecting surface comprises a first hole formed in the first elongated heat sink body at a second end of the first elongated heat sink body opposite the first LED coupling surface; and
 - (b) the second lead connecting surface comprises a second hole formed in the second elongated heat sink body at a second end of the second elongated heat sink body opposite the second LED coupling surface.
- 18.** The observation instrument of claim **12** wherein the observation instrument is selected from a group consisting of an endoscope, an exoscope, and a borescope.

* * * * *

专利名称(译)	散热器结构和LED散热器组件		
公开(公告)号	US20170343203A1	公开(公告)日	2017-11-30
申请号	US15/166024	申请日	2016-05-26
[标]申请(专利权)人(译)	卡尔史托斯影像有限公司		
申请(专利权)人(译)	KARL STORZ IMAGING , INC.		
当前申请(专利权)人(译)	KARL STORZ IMAGING , INC.		
[标]发明人	BIRNKRANT DASHIELL		
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IPC分类号	F21V29/70 H01L33/62 G02B23/24 F21V19/00 F21V5/04 H01L33/64 A61B1/06		
CPC分类号	F21V29/70 H01L33/642 H01L33/647 H01L33/62 F21Y2101/02 G02B23/2461 F21V5/04 A61B1/0684 F21V19/0025 A61B1/0676 A61B1/128 F21Y2101/00		
其他公开文献	US9927113		
外部链接	Espacenet USPTO		

摘要(译)

散热器包括第一和第二细长散热器主体。第一和第二细长散热器主体各自由相应的导电和导热材料形成，并且每个都从散热器的LED耦合端延伸到散热器的前端。电绝缘体材料将第一和第二细长散热器主体连接在一起，以使主体彼此电隔离。每个细长的散热器主体还包括位于散热器的LED耦合端处的相应LED耦合表面和位于相应主体上的与散热器的LED耦合端间隔开的位置处的相应引线连接表面。

